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DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSI RAIGAD -402 103

Mid Semester Examination - March - 2019

Branch: M. Tech (EPS)

Sem.:- II

Subject with Subject Code:- Power System Dynamics and Control

Marks: -20

MTEPS 201

Date: - 11/03/2019

Time:-1 Hr.

Q1. Attempt any one of the following.

(08 Marks)

- a) Draw the functional block diagram of excitation system and explain all the elements in detail
- b) Derive stator equations for small signal stability analysis of single machine infinite bus System.

Q2. Attempt any three of the following.

(12 Marks)

- a) What is power system stabilizer? Draw block diagram and explain briefly
- b) Explain in detail the effect of AVR on synchronizing and damping torque components.
- c) Write the Swing equation and explain all the terms involved in it.
- d) What are the different states of operation. Explain each one of them.

DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LONERE – RAIGAD -402 103

Mid Semester Examination – 2019

Branch: M.Tech Electrical Power System (EPS)

Sem.:- II

Subject with Subject Code: - Advance Power System Protection MTEPS202

Date: -

Time: - 1 Hr.

Max.Marks:20

Instructions: -

1. Solve any two.

2. Assume suitable data if it is necessary.

Q.No.1

Derive the general equation for two input phase comparator.

(10)

Q. No. 2

What is basic principal of Time-overcurrent relays? Draw and explain Definite Time Overcurrent Relay. (10)

Q. No. 3

What is Sampling Comparator? Analyze Realization of reactance and MHO relay using sampling comparator. (10)

Mid Semester Examination – MARCH-2019

Course: M. Tech in _EPS		Sem: II
Subject Name: Smart Gi	Subject Code: MTEPS203-2	
Max Marks: 20	Date:-13 th MARCH 2019	Duration:- 1 Hr.
Instructions to the Student 1. All questions are co		
2. 3. 4.		

		ivialNo
Q. 1	Solve Any One of the following.	08
(A)	Explain Wide area monitoring system.	
(B)	Explain the various technologies of smart grid.	
Q.2	Solve Any Three of the following.	12
(A)	Explain "Key challenges in smart grid"	
(B)	Give the function of smart grid components.	

(C) Write a note on general view of the smart grid market drivers.

What is the role of stakeholders?

*** End ***

DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LONERE - RAIGAD -402 103

Mid Semester Examination – March - 2019

Branch: M.Tech (EPS)

Sem .:- I

Subject with Subject Code:-M & SPES

Marks: 20

Date:-

Time:- 1 Hr.

All The Best (if any) Instructions:-

(Marks)

Q.No.1

(80)

- 2.) Explain single phase rectifier with R-L load. Draw Simu link model of same. Attempt any one of the following.
 - b.) State and explain challenges in computer simulation.

(12)

- Q.No. 2 . Attempt any three of the following: a.) Explain trapezoidal method of integration for time domain analysis.
 - b.)Compare circuit oriented simulator with equation solver.
 - c.)Draw circuit and simu link model of single phase inverter.
 - d.) Draw symbols and schematic representation of SCR,IGBT,MOSFET,Diode.

(short answer questions 4 marks each)

DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LONERE -**RAIGAD -402 103**

Mid Semester Examination - March - 2019

Sem.:- II Branch: M.Tech (EC)

Marks: 20 Subject with Subject Code: - ADSP (MTEEC201)

Time:- 1 Hr. Date: - 11/03/2019

(Marks) Instructions:-

- 1. Check whether you have got correct question paper.
- 2. Assume suitable data if necessary.
- 3. Figure to right indicates full marks.

Solve the following O.No.1

(06)

- 1) In cascade form of realization, how many bits should be used to represent the FIR filter coefficients in order to avoid the quantization effect on filter coefficients?
 - **a.** 5 to 10 **b.** 12 to 14 **c.** 20 to 24
- **d.** 28 to 40
- 2) Which among the following has/have a provision to support an adaptive filtering mechanism? e idolonia si mili
 - a.-IIR
- **b.** FIR **c.** Both a and b **d.** None of the above
- 3) Which function has a provision of determining the similarity between the signal and its delayed version?
 - a. Auto-correlation Function
- b. Cross-correlation Function

c. Both a & b

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- d. None of the above
- 4) What does the spectral density function of any signal specify?
- a. Distribution of energy or power
- b. Consumption of energy or power
- c. Conservation of energy or power

Autopresion with a state of the

d. Generation of energy or power? direit ay**ed** vo

- 5) Padding of zeros increases the frequency resolution.
 - a. Tru

- b. False
- 6) Time shifting of discrete time signal means
- $\mathbf{a.} \, \mathbf{y[n]} = \mathbf{x[n-k]}$
- **b.** y[n] = x[-n-k]
- $\mathbf{c.} \ \mathbf{y}[\mathbf{n}] = -\mathbf{x}[\mathbf{n-k}]$
- $\mathbf{d.} \ \mathbf{y[n]} = \mathbf{x[n+k]}$
- Q.No. 2 Attempt any Two of the following:

(06)

- **a.)** Explain adaptive interference mitigation in radar systems.
- b.) Derive the expression for computing kalman gain.
- c.) Explain feed forward control system.
- Q.No. 3 Attempt any One of the following:

(08)

- **a.)** Any process that can be factored is call as regular process. Justify this statement and describe the properties of regular process.
- **b.)** Explain operation for wiener filter and derive an expression for the minimum mean square error.

DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LONERE – RAIGAD -402 103

Mid Semester Examination – March - 2019

	40
Branch: M.Tech. (Electronics Engineering)	Sem.:- II
Subject :- NanoElectronics	Subject Code:- (MTEEC202)
Time:	- 1 Hr. Marks: 20
Date:- 12/03/2019	=======================================
Instructions:- Assume suitable data	(6)
Q.No.1 Attempt following Questions	(6)
t) In CVD high temperaturesare used to develop till	in films.
A) 200 250°C R) 400~550°C C) 000~90 C	D)100 130 C
2) Laser printing method is sometimes called planographic p	printing since the image and non-image
areas are in the same plane.	
D) Folio	1 1:00 -4:
2) In Diffractometer, the identification of a component of t	the sample from its powder diffraction
of lines and their re	elative·
A) Number, length B) Number, intensity C) Position, ler	ngth D) Position, intensity
1) Tunnel diode has a very fast operation in	
A) gamma frequency region B) ultraviolet frequency	region
ov in a superior frequency region D) radio trequency region	egion
5) In MESFET, an applied signal at the gate modulates the	electron carriers; this produces
in the EFT	· · · · · · · · · · · · · · · · · · ·
A) voltage amplification B) voltage attenuation C) ele	ectron multiplication
D) electron recombinationWhat is scanning tunneling microscopy reveals period	dic structure with atomic dimentions? What
exactly seen A) The atomic lattice B) electronic density of states mo	odulations associated to the atomic lattice
C)Fermilevel modulations associated to the atomic lattice	ce
D) the electron diffraction pattern associated to the atom	nic lattice
D) the electron unitraction pattern associates as	
Q.No. 2 Attempt any two of the following:	(3x2)
a) Find the number of Hexagon per unit cell and	radius of 11,10
7 ia 7 ag nanotuhe	
b) Ubstrate the design structure for ferroelectri	ic FET.
e) What are the types of Superconductor? Descri	De II.
O No 2 Attempt any one of the following	(00)
The following properties of Carbon Na	anotubes
i) Electrical Properties ii) Vibrational Proper b) List the type of Etching and Describe Wet a	Ties III) Mechanical Troperties
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	DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LO Mid Semester Examination – Mar 2019		
	Course: M. Tech in F.Y. (ECT) Subject Name: Advanced Biomedical Signal Processing Subject Code: N	1	
	Instructions to the Students: 1. Check question paper correct or not. 2. Draw net and labeled signals.	_	
	2. Draw net and labeled signals.	Co level	Marks
Q. 1	Attempt following questions		6
1	What is diagnostically useful frequency range? a)0.025 to .05Hz b).05 to 150 Hz c)150 to 200 Hz d).05 to 150 MHz	1	
2	The SA node fires at a rate of ——— a)60-100 bpm b)40-60 bpm c)80-90 bpm d)60-80 bpm	1	
3	What area of Heart forms the QRS part of an ECG? a)Purkinje fibers b)left and right bundles. c)AV node d)SA node	1	
4	a)QRS complex b)R-R interval c)ST segment d) T-P interval		
5	From instrument point of view, heart is a —— system a) Hydraulic b) pneumatic c) electronic d) electrical	1	
6	Source of Biomedical potential is —— in nature a)Electronic b)electric c)Ionic d) mechanical	1	3 X
Q.2	Solve Any Two of the following.		3 A
(A)	Chiamadical signal analysis	1	
(B)	Explain computer Aided diagnosis	1	
(C)	I amplied to FEG signals	3	
Q. 3	Solve Any One of the following.	eat 2	
(A)	Explain PCG with three channel simultaneous record of PCG,ECG and carotid with no sketches of the genesis of heart sound.	eat 2	
	Explain generation of QRS detection signal in ST/AR HP system		

DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LONERE – RAIGAD -402 103

Mid Semester Examination – March - 2019

Class: M. To Sem.:- II	ech (Electronic Engg.)	
a 1: 4. O-	tical Fiber Communication (MTEEE233)	Marks: 20
Subject:-Op	tical Fiber Communication (XXX = 2-2-3)	
Date: - 13/03	3/2019	Time:- 1 Hr.
Instructions	s: Assume suitable data if required.	
		(Marks)
Q.No.1	Attempt any six of the following:	(06)
	a.) Define Acceptance angle.b.) Give the classification of fibers.	
	c) What is Fresnel reflection?	
	d.) State the requirements of fiber materials.	
	e.) List the draw backs of fibers.	
	f.) Define critical angle. g.) What is Meridional Ray?	
	h.) Define Numerical Aperture.	(06)
Q.No. 2	Attempt any two of the following:	(00)
	a.) Discuss OVD technique of fiber fabrication. b.) A silica fiber has core RI=1.50, cladding RI=1.47. Calculate (i) Cri	tical angle
	(ii) NA (iii) Acceptance anglec.) Derive modal analysis of graded index fiber.	
Q.No.3	Attempt any one of the following: a.) Discuss Ray analysis of optical fiber.b.) What is splice? State its types and explain any one splicing techniques.	(08) ne.

	DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LO	NERE	
	Mid Semester Examination201 😇		
	Course: M. Techin _Manufacturing EngineeringSem: II		
	Subject Name: Casting and Moulding TechnologySubject Code: MMF202M	ax	•
	Marks: 20 Date:-12/03/19 Duration:-1 Hr.		
	Instructions to the Students:		
	 Assume suitable data wherever required. Draw figure wherever necessary. Figure to right indicates full marks. 		
 		(Level/	Marks
		CO)	
71	Solve all the Multiple Choice Questions		1 X 6=6
<u> </u>	1During melting process flux is added to react with impurities to form	CO2	1
	a) Cavity b) Slag c) Cold shut		
	d) Blow holes		
	2.Defects caused by the chilling of the casting are known as a) Hot spots	CO2	1
	b) Hot tears		
	c) Shrinkage cavity d) Swell		
(₁).	When the molten metal is put into the mold, what is that temperature called? a) Melting temperature	CO1	1
	b) Vapourising temperature c) Pouring temperature d) Room temperature		
	4. which are made of two or more different materials combining the	CO1	
	advantages of each material. a) Permanent molds	COI	
	b) Expendable molds c) Composite molds		
	d) none of the mentioned		
	5Which of the following characteristics is mainly considered for the solidification of castings?	CO3]
	a) Appearance b) Crystal structure		
	c) Moulding capacity d) Surface finish		

	DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LO	VERE	
	Mid Semester Examination 2015		
	Course: M. Techin _Manufacturing EngineeringSem: II		
	Subject Name: Casting and Moulding TechnologySubject Code: MMF202M	ax	
	Marks: 20 Date:-12/03/19 Duration:-1 Hr.		
	Instructions to the Students:		
· .	 Assume suitable data wherever required. Draw figure wherever necessary. Figure to right indicates full marks. 		
		(Level/	Marks
		CO)	
71	Solve all the Multiple Choice Questions		1 X 6=6
<u> </u>	1During melting process flux is added to react with impurities to form	CO2	1
	a) Cavity b) Slag c) Cold shut	·	
	d) Blow holes		
	2.Defects caused by the chilling of the casting are known as	CO2	. 1
	a) Hot spots b) Hot tears		
	c) Shrinkage cavity		
	d) Swell		
7. 1	3. When the molten metal is put into the mold, what is that temperature called?	CO1	1
	a) Melting temperature b) Vapourising temperature		
	c) Pouring temperature d) Room temperature		•
		001	
	4 which are made of two or more different materials combining the advantages of each material.	CO1	1
	a) Permanent molds b) Expendable molds		
	c) Composite molds		
	d) none of the mentioned		
	5Which of the following characteristics is mainly considered for the solidification of	CO3	1
	castings? a) Appearance		
	b) Crystal structure c) Moulding capacity		
	d) Surface finish		
	i de la companya de	· •	i

	Mid Semester I	Examination –March 2	2019		
	Course: M. Tech in Manufacturing		Sem	: II	
	Subject Name: Metal Forming Process	es	Subject Cod	e: MME21	
	Max Marks: 20	Date:- / 03 /2018	Durat	ion:-1 Hr.	,
	Instructions to the Students: 2. All question are compulsory 2. Assume suitable data, if necessar	y			
		- 		(Level/CO)	Marks
Q. 1	Solve following				1X6
	1.Define four high Rolling process			1	
	2. Define upsetting type of forging process	SS		1	
	3. Explain the plasticity	· · · · · · · · · · · · · · · · · · ·		1	
	4.Enlist defects in wire drawing component	ents		2	
	5. Explain the direct extrusion			2	
	6.What is upper bound theorem 2			2	
. :					
Q.2	Solve Any Two of the following.				3 X 2
(A)	Explain the yield criterion applied for for	ming processes		1	
(B)	Explain pressure distribution in rolling pr	rocess		2	
(C)	Explain the wire drawing process in deta	il.		3	
Q. 3	Solve Any One of the following.				8
(A)	Derive an equation for total forging force	in case of disc forging		1	
(B)	Explain the rolling process, derive an eq position.	uation for state of stres	s in equilibrium	2	

	DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LO	NERE	
	Mid Semester Examination – March 2019		
	Course: M. Tech in -Manufacturing Engineering Sem: III		
	Subject Name: Elective-III- Management Information Systems		
į	Subject Code: MME23D Max Marks: 20		
	Date:- Duration:- 1 Hr.		
	Instructions to the Students: 1. Assume suitable data wherever required. 2. Draw figure wherever necessary. 3. Figure to right indicates full marks.		
		(Level	Marks
		/CO)	
2.1	Solve all the Questions		1 X 6=
	1. What is Management & Information System?	1	- i dina
	2. What are the fundamentals of strategic advantage?	1	
	3. What is Telecommunication & Networks?	1	
	4. What is system Software?	1	
	5. Enlist the components Management of Information System?	1	
	6. What is Computer System management?	2	
Q.2	Solve Any Two of the following.		3 X 2=
(A)	Explain the use of Information System in Business.	2	
(B)	Explain in detail Networked Enterprise.	3	
(C)	Write a note on Changing environment and its impact on Business.	1	
Q. 3	Solve Any One of the following.		1X 8=
(A)		1	
(B)		2	
	*** End ***	1	

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	TEGUNOLOGICAL UNIVERSITY, LON	ERE	1963 - J
$\overline{\mathbf{D}}$	R. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LON		
1	Mid Semester Examination		
Co	urse: M. Tech in Manufacturing Engineering bject Name: Ele-IV, World Class Manufacturing Subject Code: MME24 Date:-	F	
Su	biect Name: Ele-IV, World Class Manufactures Date:-		
Ma	ax Marks: 20		
1	ration:-1 Hr.		
In:	structions to the Students: 1. Assume suitable data wherever required. 2. Draw figure wherever necessary.		
	2. Draw figure wherever needs and serious figure to right indicates full marks.	(Level/	Mar
	3. Figure 13-15	co)	
		+	1 X 6
	Solve any six of the following:	CO2	
Q. 1		CO2	
а) What is Benchmarking?		
t) What is bottleneck?	CO2	
	b) What is bottlehead: c) Define challenges in world class manufacturing?	CO2	+
1	world Class Manufacturing.	CO2	
	d) List the best practices in world extend to be world class manufacturing? e) What are the systems and tools used for world class manufacturing?	602	
1	e) What are the systems and tools used	CO2	
	f) Explain Giving example Toyota Production System.	CO3	1
	g) What is Lean Production?		3 X
	g) What is Lean 1 to be	CO3	
Q.2	Solve Any Two of the following.		
(A)	Explain the concept of FMS. Classify FMS Explain the concept of FMS. Classify FMS Explain through Rapid Prototyping?	CO	' \
(B)	Explain the concept of FMS. Classify FMS How to Improve Product & Process Design through Rapid Prototyping?	CO	3
	How to apply 5-S system in Industry?		
(C)	How to apply	$ \frac{1}{\cos}$	3
	C. Howing	L	
Q.3		CC	
(A)	What are the Models for manufacturing excellence? What are the Models for manufacturing excellence?	CC	D3
(B)	Total Productive maintenance? How it say		
-	*** End ***		

	DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, L	ONERE	
	Mid Semester Examination – March 2019		
	Course: M. Tech in Structural Engineering Semester: IV	***************************************	
	Subject Name: Theory of Plates and Shells Subject Code:	CVSE201	
	-	ion: 1 Hour	
	 Instructions to the Students: Assume suitable data wherever necessary and State it clearly. Figures to Right Indicate full Marks. C1 indicate remembering Level, C2 indicates understand Level & C3 indicates, C4 indicates Evaluate Level, C5 indicates Synthesize level 	icates Apply	
	QUESTIONS	(CO/ Level)	Marks
Q. 1	Attempt following Questions (6 Marks)		6
	1. State the boundary conditions for clamped edge rectangular plate.	CO 2, C2	
	2. Define thick plate bending.	CO 1, C1	
	3. State Governing differential equation for rectangular Plate.	CO 1, C1	
	4. State Navier's assumption for transverse load and deflection of beam for	CO 2, C1	
	uniformly distributed load.	# 	
	5. State Levy's assumption for boundary condition of plate.	CO 2, C1	
	6. State the relationship between Moment and curvature for rectangular plate.	CO 1, C1	
Q.2	Solve Any TWO of the following.		6
(A)	Sketch the free body diagram of a circular plate element representing lateral	CO3, C2	
(A)	loads, Moments and Shears.		
(B)	Using Navier's method find maximum deflection for a square plate of side	CO2, C2	
,	3m, thickness 120 mm and load 3 KN/ m ²		
(C)	Using Navier's method find particular coefficient q _{max} of the series.	CO2, C2	
Q. 3	Solve ANY ONE of the following.		8
(A)	Discuss Navier's solution for simply supported rectangular plate subjected to	CO 2, C3	
	sinusoidal loading. Hence find the expression for transverse deflection of		
4.1	plate.		
(B)	Derive Governing Differential equation for circular plate.	CO 3, C3	
	*** End ***		

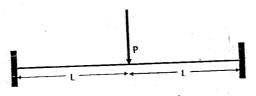
DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY LONERE, RAIGAD, 402 103

Mid Semester Examination - March 2019

Semester II Branch: M. Tech. (Structural Engineering) 2018 - 2019 Subject: Finite Element Methods Marks 20 Subject Code: CVSE-202 Date: -2019 Time: I hour 1. The first question is compulsory Instructions: 2. Show your computations upto the fourth place of decimal. 2×4 Answer any two: Q. 1 (a) What are different steps of an FEM. (b) Derive the shape functions of a spring element. (c) Explain Galerkin method in brief.

Solve $\phi'' + \phi' - 2\phi = 0$, with $0 \le x \le 1$ with boundary conditions 12 Q. 2 $\phi(x=0)=0, \phi(x=1)=1$, by using the least square method.

Analyse the beam shown in the following figure by using FEM, where the 12 Q. 3 product of elasticity E, and the moment of inertia I is a constant.



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DR.BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LONERE Mid Semester Examination- March 2019

Course: FY -M.Tech-Structural Engineering Sem: II

CVSE-E4-01 Subject Name: El-IV- Design of Tall Subject Code: **Buildings Duration:** Date: Max.Marks:2 1 Hr. 14/03/19

Instructions to the Students:

1. Illustrate your answers with near sketches, diagrams etc. where ever necessary.

2. Necessary data is given in the respective questions. If such data is not given, it means that the knowledge of that data is a part of the examination. Marks

		CO Level	Marks
Q.		Attempt any three of the following Questions.	2*3
1	1.	Define Tall Building and Dead load acting on CO1 C1	
	2.	RCC structures. Enlist major factors of Design criteria for wind CO1 C3	
		Load.	
	3. 4.	Enlist live load reduction criteria Enlist the assumptions made in the approximate CO3 C2	
Q.		analysis of the structures Solve any Two of the following	3*2
2		D. Lling analysis CO3 C2	*
ř	(A) (B)	Write a short note on Buckling analysis Explain load transfer mechanism in braced rigid CO2 C1	,
	(C)	frame structures Write a short note on Gravity load acting on CO1 C1	
Q.		structures Solve any One of the following	8
Q. 3	(A)	Explain when dynamic analysis is needed to be carried out for structures as per IS 875 Part III. State different methods to perform dynamic wind	
•	(B)	analysis of structures Explain with figure working of out trigger truss CO3 C2	
	(-)	structural system	ek ing operant of e

END

Mid Semester Examination – March 2019

Course: M.Tech. in Structural Engineering

Sem: IV

Subject Name: Retrofitting of Structures

Subject Code: CVSE-E3C

Max. Marks: 20

Date: 13/03/2019

Duration: - 1 Hr

Instructions to the Students:

1. All questions are compulsory.

2. Respective marks for question are indicated at right. All sub-questions carry equal marks.

		4 cont/CO)	Marks
Q.1	Answer the following.		06
	1. What is the effect of pozzolanas in concrete?	- "CO1	
	2. What are the dis-advantages of having less cover to the	, CO2	
	reinforcement in concrete?		·
	3. Define coefficient of thermal expansion.	5 CO1	
	4. What are the effects of dampness in the structure?	/CO2	
	5. What are the factors against which a steel structure is	Yamaraha,CO1	
	considered as weak?		;
	6. What are the common materials of masonry?	; CO2	
Q.2	Attempt any two of the following:		06
	1. What is the need for quality assurance?	CO1	
	2. What are the causes of dampness in the structure?	/CO2	
	3. Compare the rate of steel corrosion in Mumbai and	%o.	
	Aurangabad.		
Q.3	Attempt any one of the following.		08
	1. Describe in details the shrinkage in concrete and remedial	CO2	-
	measures against that.		
	2. Write a short note on:	CO1	
	(i) Rebound hammer test		
	(ii) Ultrasonic pulse velocity test		

Mid Semester Examination - March 2019

Course: M. Tech (Computer Science & Engineering)

Sem: II

Subject Name: Data Science

Subject Code: MTCE1201

Max Marks: 20

Date: - 11th March 2019

Time:-1 Hr.

Instructions to the Students:

• Assume appropriate data if necessary

• Draw neat diagram wherever necessary

Q. 1 Attempt any one of the following

a) Different between linear and logistic regression

b) Is text mining the same as information extraction? Why?

Q.2 Attempt any Three of the following

(12)

a) Apply single link or min hierarchical clustering on following (x,y) coordinates of 6 points.

Pont	x-coordinate	y-coordinate
P1	0.40	0.53
P2	0.22	0.38
Р3	0.35	0.39
P4	0.26	0.19
P5	0.08	0.41
P6	0.45	0.30

- b) How R-Squared value metric is used for linear regression model evaluation? Explain with example.
- c) Would the cosine measure be the appropriate similarity measure to use with K-means clustering? Why or why not?
- d) The 'database' below has four transactions. What association rules can be found in this set, if the minimum support (i.e coverage) is 2.

Trans_id	Itemlist
T1	$\{K, A, D, B\}$
T2	$\{D, AC, E, B\}$
T3	$\{C, A, B, E\}$
T4	B, A, D}

*****FND*****

Mid Semester Examination - March 2019

Course: M. Tech (Computer Science & Engineering)

Sem: I

Subject Name: Software Architecture

Subject Code: MTCE1202

Max Marks: 20

Date: - 12th March 2019

Time: -1 Hr.

Instructions to the Students:

I. Assume appropriate data if necessary

II. Draw neat diagram wherever necessary

Q. 1 Attempt any one of the following

(08)

- a) Identify the two important techniques that software engineering uses to tackle the problem of exponential growth of problem complexity with its size.
- b) Identify three reasons for the necessity of developing a prototype during software development.

Q.2 Attempt any Three of the following

(12)

- a) Explain Decomposition style with reference to the terms: elements, relations and properties.
- b) What does the term "balancing a DFD" mean? Give an example to explain your answer. Also, explain top down decomposition in the context of structured analysis?
- c) List and explain the seven rules for documentation.
- d) Represent the following relations among classes using UML diagram.
 - 1. Students credit 5 courses each semester. Each course is taught by one or more teachers.
 - 2. Bill contains number of items. Each item describes some commodity, the price of unit, and total on this price.
 - 3. An order consists of one or more order items. Each order item contains the name of the item, its quantity and the date by which it is required. Each order item is described by an item type specification object having details such as its vendor addresses, its unit price, and the manufacturer.

****END****

DR. BABASAHEB AMBEDKAR TECHNOLOGICAL UNIVERSITY, LONERE. Mid Semester Examination – MARCH-2019

Course: M. Tech (Computer Science & Engineering)

Sem: II

Subject Name: Mobile Computing

Subject Code: MTCE1204

M. ESE

Time:-1 Hr.

Max Marks: 20

Date:- 14th Mar 2019

Instructions to the Students:

Assume appropriate data if necessary I.

Draw neat diagram wherever necessary II.

Q. 1 Attempt any one of the following

(08)

- a) With Suitable diagram Explain android activity lifecycle. Create an android application having TextView, EditText and Button.
- b) State the challenges present in development of android application. Write an android application for performing basic arithmatic operations.

Q.2 Attempt any Three of the following

(12)

- a) What is intent? Explain Explicit vs Implicit Intent with suitable program.
- b) Describe in detail Adaptive Layout with suitable example.
- c) Explain Categories of Activities in detail.
- d) Enlist Different UI Elements in Android with description.

*****END*****

Mid Semester Examination - March 2019

Course: M. Tech (Computer Science & Engineering)

Sem: II

Subject Name: ELE-3 Software Testing

Subject Code: MTCE1203

Max Marks: 20

Date: - 13th March 2019

Time: - 1 Hr.

Instructions to the Students:

- I. Assume appropriate data if necessary
- II. Draw neat diagram wherever necessary

Q. 1 Attempt any one of the following

(08)

- a) List three challenges from the testing perspective for each of the following models:
 - I) Spiral Model
 - II) Waterfall Model
- b) Explain Structure-based testing techniques.

Q.2 Attempt any Three of the following

(12)

- a) Compare & contrast between equivalence class partitioning & Boundary value analysis.
- b) Which technique can be used to achieve input and output coverage? Whether, it can be applied to human input, input via interfaces to a system, or interface parameters in integration testing, Justify.
- c) An input field takes the year of birth between 1900 and 2002. What are the boundary values for testing this field?
- d) Given the following code, which statement is true about the minimum number of test cases required for full statement and branch coverage?

Read p

Read q

IF p+q > 100

THEN Print "Large"

ENDIF

IF p > 50

THEN Print "p Large"

ENDIF .

*****END****